

**WINSTAR Display**

## **OLED SPECIFICATION**

Model No:

***WEA012864DWPP3N00001***

# SPECIFICATION

Version: C

**CUSTOMER :**

**MODULE NO. :** WEA012864DWPP3N00001

**APPROVED BY:**

( FOR CUSTOMER USE ONLY )

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY
RELEASE DATE:			

☒ APPROVAL FOR SPECIFICATIONS ONLY

☐ APPROVAL FOR SPECIFICATIONS AND SAMPLE

**MODEL NO :**

RECORDS OF REVISION			DOC. FIRST ISSUE
VERSION	DATE	REVISED PAGE NO.	SUMMARY
0	2018/03/28		First release
A	2018/04/20		Modify Application recommendations
B	2018/07/20		Modify ICC to IDD, Application Circuit
C	2018/11/27		Modify Static electricity test Content of Test

# Contents

- 1.Module Classification Information
- 2.General Specification
- 3.Contour Drawing & Block Diagram
- 4.Interface Pin Function
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- 6.Electrical Characteristics
- 7.Optical Characteristics
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- 9.Reliability
- 10.Inspection specification
- 11.Precautions in use of OLED Modules

# 1.Module Classification Information

W E A 012864 D W P P 3 N 0 0 0 01  
 ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪ ⑫ ⑬ ⑭

1	Brand : WINSTAR DISPLAY CORPORATION			
2	E : OLED			
3	Display Type	H : COB Character	G : COB Graphic	
		O : COG	F : COG + FR	
		P : COG + FR + PCB	X : TAB	
		A : COG + PCB		
4	Dot Matrix : 128 * 64			
5	Serials code			
6	Emitting Color	A : Amber	R : Red	C : Full Color
		B : Blue	W : White	
		G : Green	L : Yellow	
		S : Sky Blue	X : Dual Color	
7	Polarizer	P : With Polarizer; N: Without Polarizer A : Anti-glare Polarizer		
8	Display Mode	P : Passive Matrix ; N : Active Matrix		
9	Driver Voltage	3 : 3.0~3.3V ; 5 : 5.0V		
10	Touch Panel	N : Without touch panel; T: With touch panel		
11	Product type	0 : Standard 1 : Daylight Readable 2 : Transparent OLED (TOLED) 3 : Flexible OLED (FOLED) 4 : OLED Lighting		
12	Inspection Grade	0 : Standard 2 : Special grade C : Automotive grade Y : Consumer grade		
13	Option	0 : Default ; F : ZIF FPC ; H : Hot bar FPC; D : Demo Kit		
14	Serial No.	Serial number(00~ZZ)		

## 2.General Specification

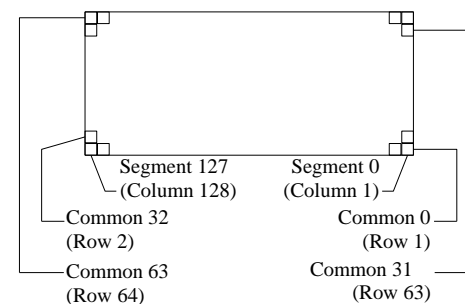
Item	Dimension	Unit
Dot Matrix	128 x 64 Dots	—
Module dimension	38.00 x 28.50 x 2.37	mm
Active Area	21.74 x 10.86	mm
Pixel Size	0.148 x 0.148	mm
Pixel Pitch	0.17 x 0.17	mm
Display Mode	Passive Matrix	
Display Color	White	
Drive Duty	1/64 Duty	
IC	SSD1306BZ	
Interface	I2C,Optional SPI	
Size	0.96 inch	

The drawing shows the mechanical specifications of the M100 camera module. The top view includes the following dimensions:

- Overall width:  $38 \pm 0.5$
- Overall height:  $28.5 \pm 0.5$
- Distance from top edge to I/O pins:  $5.65 \pm 0.5$
- Distance from top edge to active area:  $6.6 \pm 0.5$
- Distance from left edge to active area:  $19.26 \pm 0.2$
- Active area width:  $12.06$  (VA)
- Active area height:  $10.86$  (AA)
- Distance from left edge to I/O pins:  $2.48$
- Distance from I/O pins to active area:  $2.44$
- Distance from I/O pins to right edge:  $26.7 \pm 0.2$
- Distance from I/O pins to active area:  $23.94$  (VA)
- Distance from I/O pins to active area:  $21.74$  (AA)
- Pin 1 location:  $1$
- Pin 8 location:  $8$
- Pin labels: SDA, SA0, CS, VIN, SCL, RST, VDD, GND
- Active area label: **Active Area 0.96"**  
**128 x 64 Pixels**
- Mounting holes:  $(13)$  and  $(12)$
- Mounting hole diameter:  $4 - R3.75$
- Mounting hole depth:  $2 \text{ Max with Component}$

Technical drawing of a PCB layout for a 4x8 array of 32 LEDs. The drawing shows a rectangular board with a central array of 32 LEDs (8 rows by 4 columns). Dimensions include a total width of  $32 \pm 0.1$  mm, a total height of  $22.5 \pm 0.1$  mm, and a central LED array width of  $P0.7 * 29 = 20.3$  mm. Pin 1 is indicated at the top-left corner. A table on the right lists pin numbers 4, 5, 6, 7, and 8.

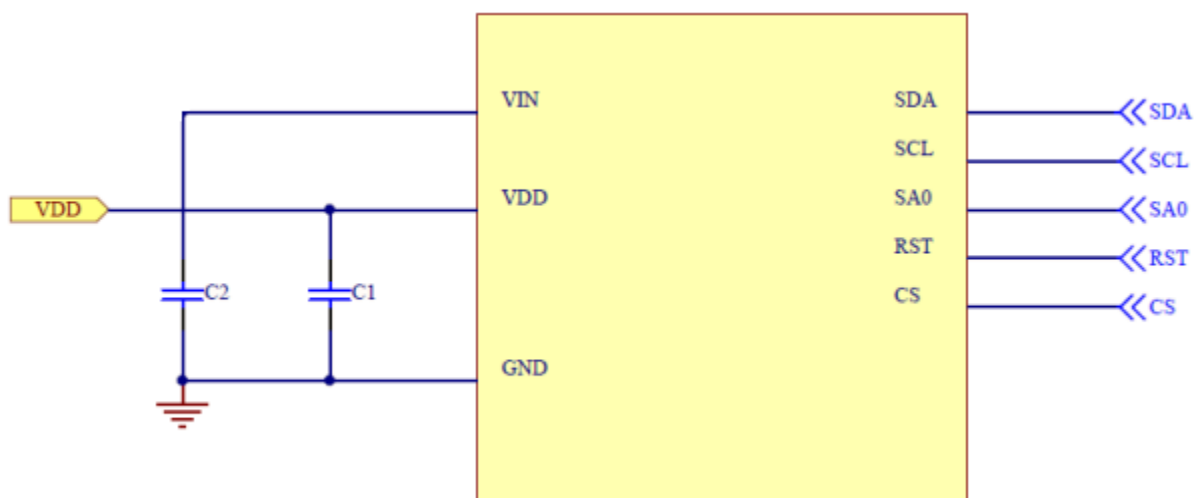
4
5
6
7
8



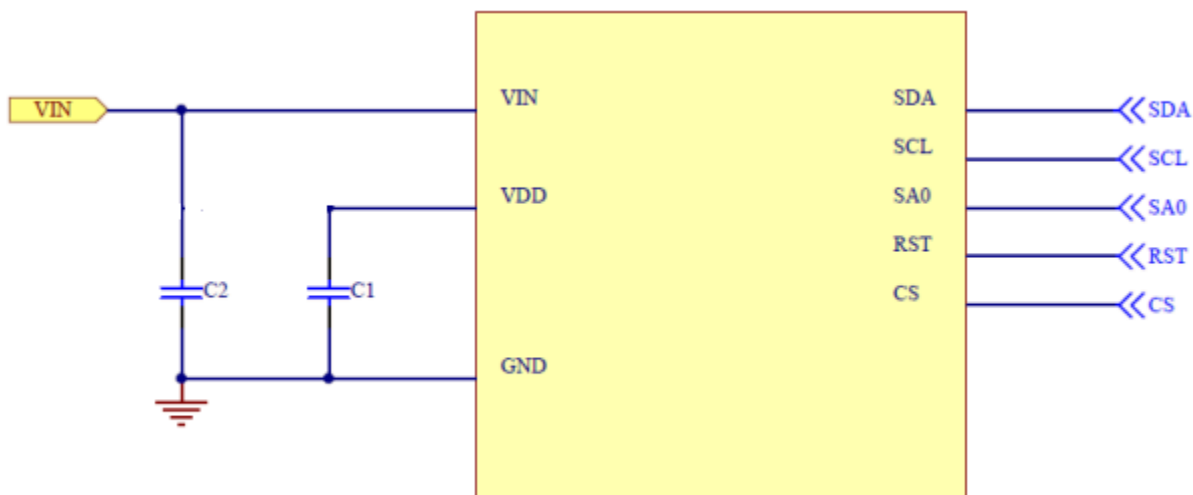
**WINSTAR**

### 3.1 Application recommendations

Application Example of VDD=3.0V :



Application Example of VIN=5.0V :



C1, C2: 1.0uF (1)

Note

(1) The capacitor value is recommended value. Select appropriate value against module application.

\*For more information, please refer to Application Note provided by Winstar.



## 4. Interface Pin Function

No.	Symbol	Function
1	MOSI_SDA	When serial interface mode is selected, D0 will be the serial clock input: SCLK; D1 will be the serial data input: SDIN. When I2C mode is selected, D2, D1 should be tied together and serve as SDAout, SDAin in application and D0 is the serial clock input, SCL.
2	SCLK_SCL	
3	DC_SA0	In I2C mode, this pin acts as SA0 for slave address selection. When 3-wire serial interface is selected, this pin must be connected to VSS.
4	RST	This pin is reset signal input. When the pin is pulled LOW, initialization of the chip is executed. Keep this pin HIGH (i.e. connect to VDD) during normal operation.
5	CS	This pin is the chip select input. (active LOW).
6	VDD	3.0V Power supply pin for core logic operation.
7	VIN	5.0V Power supply pin for core logic operation.
8	GND	This is a ground pin.

## 5. Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit	Notes
Supply Voltage for Logic	VDD	1.65	3.3	V	1,2
Supply Voltage for Logic	VIN	4.0	6.0	V	1,2
Supply Voltage for Display	VCC	0	16.0	V	1,2
Operating Temperature	TOP	-40	+80	°C	—
Storage Temperature	TSTG	-40	+85	°C	—

Note 1: All the above voltages are on the basis of “VSS = 0V”.

Note 2: When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to Section 6. “Optics & Electrical Characteristics”. If this module is used beyond these conditions, malfunctioning of the module can occur and the reliability of the module may deteriorate.

## 6. Electrical Characteristics

### 6.1 DC Electrical Characteristics

Item	Symbol	Condition	Min	Typ	Max	Unit
Supply Voltage for Logic	VDD	—	2.8	3.0	3.2	V
Supply Voltage for Logic	VIN	—	4.8	5.0	5.2	V
Supply Voltage for Display	VCC	—	7.0	7.5	8.0	V
Input High Volt.	VIH	—	$0.8 \times VDD$	—	VDDIO	V
Input Low Volt.	VIL	—	0	—	$0.2 \times VDD$	V
Output High Volt.	VOH	—	$0.9 \times VDD$	—	VDDIO	V
Output Low Volt.	VOL	—	0	—	$0.1 \times VDD$	V
50% Check Board operating Current	IDD	Vcc=7.5V	—	12.0	20.0	mA

Note : VDD or VIN can be selected as Logic Voltage

## 6.2 Initial code

```
Write_command(0xAE); // Display Off

Write_command(0xD5); //SET DISPLAY CLOCK
Write_command(0x80); //105HZ

Write_command(0xA8); // Select Multiplex Ratio
Write_command(Duty); // Default => 0~0x3F (1/64 Duty)

Write_command(0xD3); //Setting Display Offset
Write_command(0x00); //00H Reset, set common start

Write_command(0x40); //Set Display Start Line

Write_command(0x8D); // Set Charge Pump
Write_command(0x14); // Endable Charge Pump

Write_command(0xA1); //Set Segment Re-Map Default
//0xA0 (0x00) => column Address 0 mapped to 127
//0xA1 (0x01) => Column Address 127 mapped to 0

Write_command(0xC8); //Set COM Output Scan Direction

Write_command(0xDA); //Set COM Hardware Configuration
Write_command(0x12); //Alternative COM Pin---See IC Spec page 34

Write_command(0x81); //Set Contrast Control
Write_command(Contrast_value);

Write_command(0xD9); //Set Pre-Charge period
Write_command(0x22);

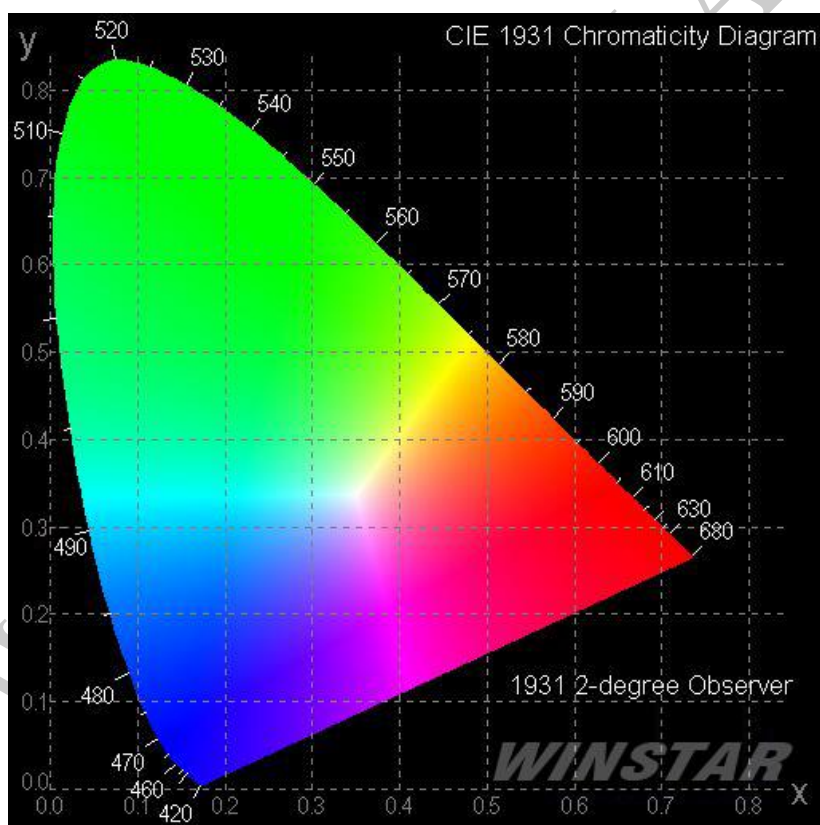
Write_command(0xDB); //Set Deselect Vcomh level
Write_command(0x30); //

Write_command(0xA4); //Entire Display ON

Write_command(0xA6); //Set Normal Display
Write_command(0xAF); // Display ON
```

## 7.Optical Characteristics

Item	Symbol	Condition	Min	Typ	Max	Unit
View Angle	(V) $\theta$	—	160	—	—	deg
	(H) $\varphi$	—	160	—	—	deg
Contrast Ratio	CR	Dark	2000:1	—	—	—
Response Time	T rise	—	—	10	—	$\mu$ s
	T fall	—	—	10	—	$\mu$ s
Display with 50% check Board Brightness			60	80	—	cd/m2
CIEx(White)		(CIE1931)	0.26	0.28	0.30	—
CIEx(White)		(CIE1931)	0.30	0.32	0.34	—



## 8.OLED Lifetime

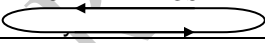
ITEM	Conditions	Min	Typ	Remark
Operating Life Time	Ta=25℃ / Initial 50% check board brightness Typical Value	20,000 Hrs	—	Note

Notes:

1. Life time is defined the amount of time when the luminance has decayed to <50% of the initial value.
2. This analysis method uses life data obtained under accelerated conditions to extrapolate an estimated probability density function (*pdf*) for the product under normal use conditions.
3. Screen saving mode will extend OLED lifetime.

# 9. Reliability

## Content of Reliability Test

Environmental Test			
Test Item	Content of Test	Test Condition	Applicable Standard
High Temperature storage	Endurance test applying the high storage temperature for a long time.	85°C 240hrs	—
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-40°C 240hrs	—
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	80°C 240hrs	—
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-40°C 240hrs	—
High Temperature/ Humidity Storage	Endurance test applying the high temperature and high humidity storage for a long time.	60°C, 90%RH 240hrs	—
High Temperature/ Humidity Operation	Endurance test applying the high temperature and high humidity Operation for a long time.	60°C, 90%RH 120hrs	—
Temperature Cycle	Endurance test applying the low and high temperature cycle. <div style="display: flex; justify-content: space-around; align-items: center;"> <span>-40°C</span> <span>25°C</span> <span>80°C</span> </div> <div style="display: flex; justify-content: space-around; align-items: center;"> <span>30min</span> <span>5min</span> <span>30min</span> </div> 	-40°C / 80°C 30 cycles	—
Mechanical Test			
Vibration test	Endurance test applying the vibration during transportation and using.	Frequency: 10~55Hz amplitude: 1.5mm Time: 0.5hrs/axis Test axis: X, Y, Z	—
Others			
Static electricity test	Endurance test applying the electric stress to the finished product housing.	Air Discharge model ±4kv, 10 times	—

\*\*\* Supply voltage for OLED system = Operating voltage at 25°C

**Test and measurement conditions**

1. All measurements shall not be started until the specimens attain to temperature stability.  
After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure test at  $23\pm5^{\circ}\text{C}$ ;  $55\pm15\%$  RH.
2. All-pixels-on is used as operation test pattern.
3. The degradation of Polarizer are ignored for High Temperature storage, High Temperature/ Humidity Storage, Temperature Cycle

**Evaluation criteria**

1. The function test is OK.
2. No observable defects.
3. Luminance:  $> 50\%$  of initial value.
4. Current consumption: within  $\pm 50\%$  of initial value.

**APPENDIX:****RESIDUE IMAGE**

Because the pixels are lighted in different time, the luminance of active pixels may reduce or differ from inactive pixels. Therefore, the residue image will occur. To avoid the residue image, every pixel needs to be lighted up uniformly.



# 10. Inspection specification

## Inspection Standard:

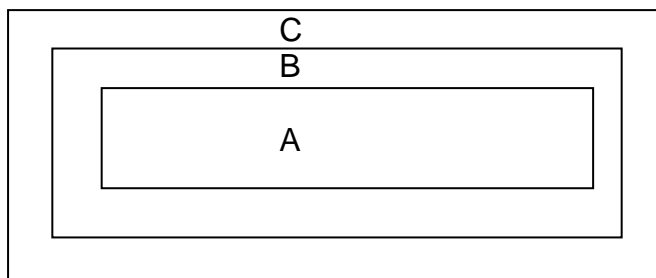
MIL-STD-105E table normal inspection single sample level II.

## Definition

1 Major defect : The defect that greatly affect the usability of product.

2 Minor defect : The other defects, such as cosmetic defects, etc.

Definition of inspection zone:



Zone A: Active Area

Zone B: Viewing Area except Zone A

Zone C: Outside Viewing Area

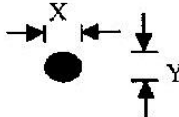
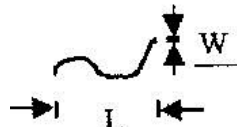
Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble of quality and assembly to customer's product.

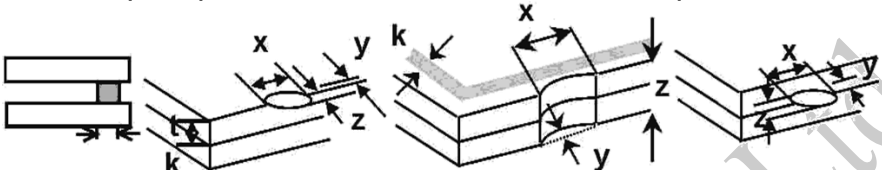
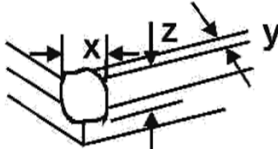
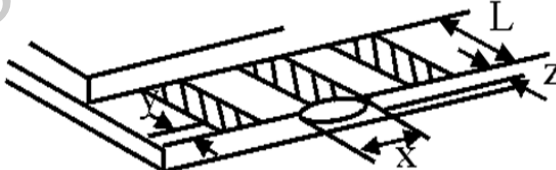
## Inspection Methods

1 The general inspection : Under fluorescent light illumination: 750~1500 Lux, about 30cm viewing distance, within 45° viewing angle, under 25±5°C.

2 The luminance and color coordinate inspection : By SR-3 or BM-7 or the equal equipments, in the dark room, under 25±5°C.

NO	Item	Criterion	AQL
01	Electrical Testing	1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character , dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 OLED viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect.	0.65
02	Black or white spots on OLED (display only)	2.1 White and black spots on display $\leq 0.25\text{mm}$ , no more than three white or black spots present. 2.2 Densely spaced: No more than two spots or lines within 3mm.	2.5


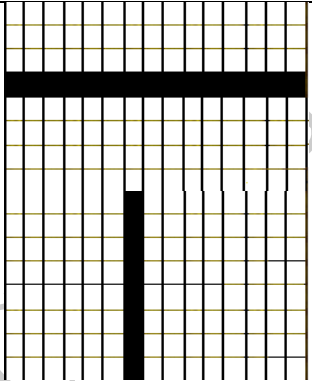
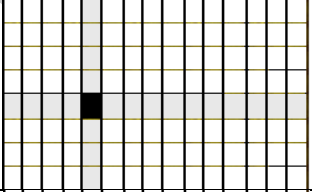
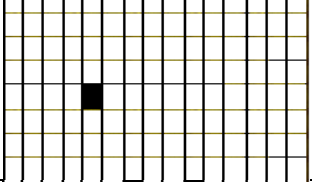
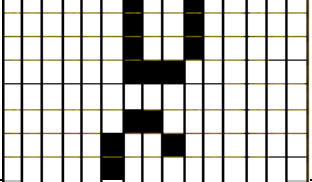
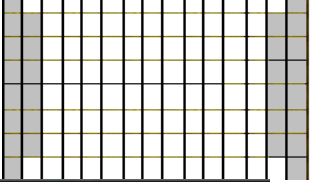
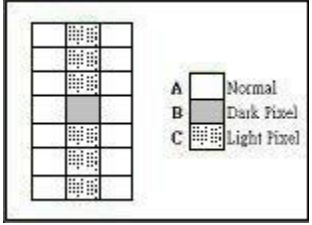
NO	Item	Criterion	AQL																		
03	OLED black spots, white spots, contamination (non-display)	<div> <div> 3.1 Round type :  As following drawing  <math>\Phi = (x + y) / 2</math>  </div> <table> <tr> <th>SIZE</th> <th>Acceptable QTY</th> <th>Zone</th> </tr> <tr> <td><math>\Phi \leq 0.10</math></td> <td>Accept no dense</td> <td>A+ B,</td> </tr> <tr> <td><math>0.10 &lt; \Phi \leq 0.20</math></td> <td>2</td> <td>A+ B</td> </tr> <tr> <td><math>0.20 &lt; \Phi \leq 0.25</math></td> <td>1</td> <td>A+ B</td> </tr> <tr> <td><math>0.25 &lt; \Phi</math></td> <td>0</td> <td>A+ B</td> </tr> </table> </div>	SIZE	Acceptable QTY	Zone	$\Phi \leq 0.10$	Accept no dense	A+ B,	$0.10 < \Phi \leq 0.20$	2	A+ B	$0.20 < \Phi \leq 0.25$	1	A+ B	$0.25 < \Phi$	0	A+ B	2.5			
	SIZE	Acceptable QTY	Zone																		
$\Phi \leq 0.10$	Accept no dense	A+ B,																			
$0.10 < \Phi \leq 0.20$	2	A+ B																			
$0.20 < \Phi \leq 0.25$	1	A+ B																			
$0.25 < \Phi$	0	A+ B																			
	<div> <div> 3.2 Line type : (As following drawing)   </div> <table> <tr> <th>Length</th> <th>Width</th> <th>Acceptable QTY</th> <th>Zone</th> </tr> <tr> <td>---</td> <td><math>W \leq 0.02</math></td> <td>Accept no dense</td> <td>A+B</td> </tr> <tr> <td><math>L \leq 3.0</math></td> <td><math>0.02 &lt; W \leq 0.03</math></td> <td rowspan="2">2</td> <td>A+B</td> </tr> <tr> <td><math>L \leq 2.5</math></td> <td><math>0.03 &lt; W \leq 0.05</math></td> <td>A+B</td> </tr> <tr> <td>---</td> <td><math>0.05 &lt; W</math></td> <td>As round type</td> <td></td> </tr> </table> </div>	Length	Width	Acceptable QTY	Zone	---	$W \leq 0.02$	Accept no dense	A+B	$L \leq 3.0$	$0.02 < W \leq 0.03$	2	A+B	$L \leq 2.5$	$0.03 < W \leq 0.05$	A+B	---	$0.05 < W$	As round type		2.5
Length	Width	Acceptable QTY	Zone																		
---	$W \leq 0.02$	Accept no dense	A+B																		
$L \leq 3.0$	$0.02 < W \leq 0.03$	2	A+B																		
$L \leq 2.5$	$0.03 < W \leq 0.05$		A+B																		
---	$0.05 < W$	As round type																			
04	Polarizer bubbles	<div> <div> If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction. <table> <tr> <th>Size <math>\Phi</math></th> <th>Acceptable QTY</th> <th>Zone</th> </tr> <tr> <td><math>\Phi \leq 0.20</math></td> <td>Accept no dense</td> <td>A+B</td> </tr> <tr> <td><math>0.20 &lt; \Phi \leq 0.50</math></td> <td>3</td> <td>A+B</td> </tr> <tr> <td><math>0.50 &lt; \Phi \leq 1.00</math></td> <td>2</td> <td>A+B</td> </tr> <tr> <td><math>1.00 &lt; \Phi</math></td> <td>0</td> <td>A+B</td> </tr> <tr> <td>Total QTY</td> <td>3</td> <td></td> </tr> </table> </div> </div>	Size $\Phi$	Acceptable QTY	Zone	$\Phi \leq 0.20$	Accept no dense	A+B	$0.20 < \Phi \leq 0.50$	3	A+B	$0.50 < \Phi \leq 1.00$	2	A+B	$1.00 < \Phi$	0	A+B	Total QTY	3		2.5
Size $\Phi$	Acceptable QTY	Zone																			
$\Phi \leq 0.20$	Accept no dense	A+B																			
$0.20 < \Phi \leq 0.50$	3	A+B																			
$0.50 < \Phi \leq 1.00$	2	A+B																			
$1.00 < \Phi$	0	A+B																			
Total QTY	3																				
05	Scratches	Follow NO.3 OLED black spots, white spots, contamination.																			

NO	Item	Criterion	AQL																		
06	Chipped glass	<p>Symbols Define: x: Chip length            y: Chip width            z: Chip thickness k: Seal width            t: Glass thickness    a: OLED side length L: Electrode pad length: 6.1 General glass chip : 6.1.1 Chip on panel surface and crack between panels:</p>  <table><tr><td>z: Chip thickness</td><td>y: Chip width</td><td>x: Chip length</td></tr><tr><td><math>Z \leq 1/2t</math></td><td>Not over viewing area</td><td><math>x \leq 1/8a</math></td></tr><tr><td><math>1/2t &lt; z \leq 2t</math></td><td>Not exceed 1/3k</td><td><math>x \leq 1/8a</math></td></tr></table> <p>⊙ If there are 2 or more chips, x is total length of each chip.</p> <p>6.1.2 Corner crack:</p>  <table><tr><td>z: Chip thickness</td><td>y: Chip width</td><td>x: Chip length</td></tr><tr><td><math>Z \leq 1/2t</math></td><td>Not over viewing area</td><td><math>x \leq 1/8a</math></td></tr><tr><td><math>1/2t &lt; z \leq 2t</math></td><td>Not exceed 1/3k</td><td><math>x \leq 1/8a</math></td></tr></table> <p>⊙ If there are 2 or more chips, x is the total length of each chip.</p>	z: Chip thickness	y: Chip width	x: Chip length	$Z \leq 1/2t$	Not over viewing area	$x \leq 1/8a$	$1/2t < z \leq 2t$	Not exceed 1/3k	$x \leq 1/8a$	z: Chip thickness	y: Chip width	x: Chip length	$Z \leq 1/2t$	Not over viewing area	$x \leq 1/8a$	$1/2t < z \leq 2t$	Not exceed 1/3k	$x \leq 1/8a$	2.5
z: Chip thickness	y: Chip width	x: Chip length																			
$Z \leq 1/2t$	Not over viewing area	$x \leq 1/8a$																			
$1/2t < z \leq 2t$	Not exceed 1/3k	$x \leq 1/8a$																			
z: Chip thickness	y: Chip width	x: Chip length																			
$Z \leq 1/2t$	Not over viewing area	$x \leq 1/8a$																			
$1/2t < z \leq 2t$	Not exceed 1/3k	$x \leq 1/8a$																			
06	Glass crack	<p>Symbols : x: Chip length            y: Chip width            z: Chip thickness k: Seal width            t: Glass thickness    a: OLED side length L: Electrode pad length 6.2 Protrusion over terminal : 6.2.1 Chip on electrode pad :</p>  <table><tr><td>y: Chip width</td><td>x: Chip length</td><td>z: Chip thickness</td></tr><tr><td><math>y \leq 0.5\text{mm}</math></td><td><math>x \leq 1/8a</math></td><td><math>0 &lt; z \leq t</math></td></tr></table>	y: Chip width	x: Chip length	z: Chip thickness	$y \leq 0.5\text{mm}$	$x \leq 1/8a$	$0 < z \leq t$	2.5												
y: Chip width	x: Chip length	z: Chip thickness																			
$y \leq 0.5\text{mm}$	$x \leq 1/8a$	$0 < z \leq t$																			

NO	Item	Criterion	AQL										
06	Glass crack	<p>6.2.2 Non-conductive portion:</p> <div><table><tr><td>y: Chip width</td><td>x: Chip length</td><td>z: Chip thickness</td></tr><tr><td><math>y \leq L</math></td><td><math>x \leq 1/8a</math></td><td><math>0 &lt; z \leq t</math></td></tr></table></div> <p>⊙ If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications.</p> <p>⊙ If the product will be heat sealed by the customer, the alignment mark not be damaged.</p> <p>6.2.3 Substrate protuberance and internal crack.</p> <div><table><tr><td>y: width</td><td>x: length</td></tr><tr><td><math>y \leq 1/3L</math></td><td><math>x \leq a</math></td></tr></table></div>	y: Chip width	x: Chip length	z: Chip thickness	$y \leq L$	$x \leq 1/8a$	$0 < z \leq t$	y: width	x: length	$y \leq 1/3L$	$x \leq a$	2.5
y: Chip width	x: Chip length	z: Chip thickness											
$y \leq L$	$x \leq 1/8a$	$0 < z \leq t$											
y: width	x: length												
$y \leq 1/3L$	$x \leq a$												
07	Cracked glass	The OLED with extensive crack is not acceptable.	2.5										
08	Backlight elements	8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using OLED spot, lines and contamination standards. 8.3 Backlight doesn't light or color wrong.	0.65 2.5 0.65										
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination. 9.2 Bezel must comply with job specifications.	2.5 0.65										
10	PCB , COB	10.1 COB seal may not have pinholes larger than 0.2mm or contamination. 10.2 COB seal surface may not have pinholes through to the IC. 10.3 The height of the COB should not exceed the height indicated in the assembly diagram. 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. 10.5 No oxidation or contamination PCB terminals. 10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. 10.7 The jumper on the PCB should conform to the product characteristic chart. 10.8 If solder gets on bezel tab pads, OLED pad, zebra pad or screw hold pad, make sure it is smoothed down.	2.5 2.5 0.65 2.5 2.5 0.65 0.65 2.5										

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NO	Item	Criterion	AQL
11	Soldering	11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB.	2.5 2.5 2.5 0.65
12	General appearance	12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP. 12.2 No cracks on interface pin (OLB) of TCP. 12.3 No contamination, solder residue or solder balls on product. 12.4 The IC on the TCP may not be damaged, circuits. 12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever. 12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color. 12.7 Sealant on top of the ITO circuit has not hardened. 12.8 Pin type must match type in specification sheet. 12.9 OLED pin loose or missing pins. 12.10 Product packaging must the same as specified on packaging specification sheet. 12.11 Product dimension and structure must conform to product specification sheet.	2.5 0.65 2.5 2.5 2.5 2.5 0.65 0.65 0.65 0.65

Check Item	Classification	Criteria
No Display	Major	
Missing Line	Major	
Pixel Short	Major	
Darker Short	Major	
Wrong Display	Major	
Un-uniform B/A x 100% < 70% A/C x 100% < 70%	Major	 

# 11. Precautions in use of OLED Modules

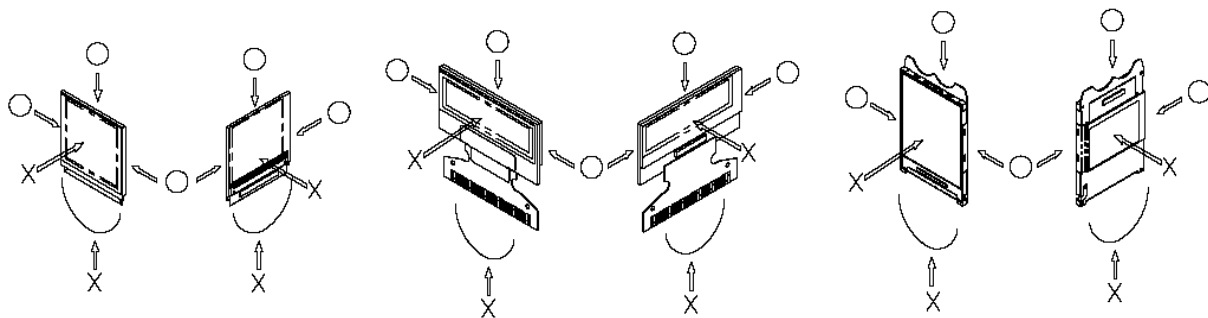
## Modules

- (1) Avoid applying excessive shocks to module or making any alterations or modifications to it.
- (2) Don't make extra holes on the printed circuit board, modify its shape or change the components of OLED display module.
- (3) Don't disassemble the OLED display module.
- (4) Don't operate it above the absolute maximum rating.
- (5) Don't drop, bend or twist OLED display module.
- (6) Soldering: only to the I/O terminals.
- (7) Storage: please storage in anti-static electricity container and clean environment.
- (8) It's pretty common to use "Screen Saver" to extend the lifetime and Don't use fix information for long time in real application.
- (9) Don't use fixed information in OLED panel for long time, that will extend "screen burn" effect time..
- (10) Winstar has the right to change the passive components, including R2 and R3 adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (11) Winstar have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Winstar have the right to modify the version.)

### 11.1. Handling Precautions

- (1) Since the display panel is being made of glass, do not apply mechanical impacts such as dropping from a high position.
- (2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
- (3) If pressure is applied to the display surface or its neighborhood of the OLED display module, the cell structure may be damaged and be careful not to apply pressure to these sections.
- (4) The polarizer covering the surface of the OLED display module is soft and easily scratched. Please be careful when handling the OLED display module.
- (5) When the surface of the polarizer of the OLED display module has soil, clean the surface. It takes advantage of by using following adhesion tape.
  - \* Scotch Mending Tape No. 810 or an equivalentNever try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent such as ethyl alcohol, since the surface of the polarizer will become cloudy. Also, pay attention that the following liquid and solvent may spoil the polarizer:
  - \* Water
  - \* Ketone
  - \* Aromatic Solvents
- (6) Hold OLED display module very carefully when placing OLED display module into the System housing. Do not apply excessive stress or pressure to OLED display module. And, do not over bend the film with electrode pattern layouts. These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases.





(7) Do not apply stress to the LSI chips and the surrounding molded sections.

(8) Do not disassemble nor modify the OLED display module.

(9) Do not apply input signals while the logic power is off.

(10) Pay sufficient attention to the working environments when handling OLED display modules to prevent occurrence of element breakage accidents by static electricity.

\* Be sure to make human body grounding when handling OLED display modules.

\* Be sure to ground tools to use or assembly such as soldering irons.

\* To suppress generation of static electricity, avoid carrying out assembly work under dry environments.

\* Protective film is being applied to the surface of the display panel of the OLED display module. Be careful since static electricity may be generated when exfoliating the protective film.

(11) Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. At this time, if the OLED display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5.

(12) If electric current is applied when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful to avoid the above.

## 11.2. Storage Precautions

(1) When storing OLED display modules, put them in static electricity preventive bags avoiding exposure to direct sun light nor to lights of fluorescent lamps. and, also, avoiding high temperature and high humidity environment or low temperature (less than 0°C) environments.

(We recommend you to store these modules in the packaged state when they were shipped from Winstar.

At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them.

(2) If electric current is applied when water drops are adhering to the surface of the OLED display module, when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful about the above.

## 11.3. Designing Precautions

(1) The absolute maximum ratings are the ratings which cannot be exceeded for OLED display module, and if these values are exceeded, panel damage may be happen.

(2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the VIL and VIH specifications and, at the same time, to make the signal line cable as short as possible.

(3) We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (VDD). (Recommend value: 0.5A)

(4) Pay sufficient attention to avoid occurrence of mutual noise interference with the neighboring devices.

- (5) As for EMI, take necessary measures on the equipment side basically.
- (6) When fastening the OLED display module, fasten the external plastic housing section.
- (7) If power supply to the OLED display module is forcibly shut down by such errors as taking out the main battery while the OLED display panel is in operation, we cannot guarantee the quality of this OLED display module.

\* Connection (contact) to any other potential than the above may lead to rupture of the IC.

#### **11.4. Precautions when disposing of the OLED display modules**

- 1) Request the qualified companies to handle industrial wastes when disposing of the OLED display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.

#### **11.5. Other Precautions**

- (1) When an OLED display module is operated for a long of time with fixed pattern may remain as an after image or slight contrast deviation may occur.

Nonetheless, if the operation is interrupted and left unused for a while, normal state can be restored. Also, there will be no problem in the reliability of the module.

- (2) To protect OLED display modules from performance drops by static electricity rapture, etc., do not touch the following sections whenever possible while handling the OLED display modules.

\* Pins and electrodes

\* Pattern layouts such as the TCP & FPC

- (3) With this OLED display module, the OLED driver is being exposed. Generally speaking, semiconductor elements change their characteristics when light is radiated according to the principle of the solar battery. Consequently, if this OLED driver is exposed to light, malfunctioning may occur.

\* Design the product and installation method so that the OLED driver may be shielded from light in actual usage.

\* Design the product and installation method so that the OLED driver may be shielded from light during the inspection processes.

- (4) Although this OLED display module stores the operation state data by the commands and the indication data, when excessive external noise, etc. enters into the module, the internal status may be changed. It therefore is necessary to take appropriate measures to suppress noise generation or to protect from influences of noise on the system design.

- (5) We recommend you to construct its software to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise.

- (6) Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.

- (7) Our company will has the right to upgrade and modify the product function.